B/O FORM PTO 1595 (1/31/92) Patent and Trademark Office RECORDATION FORM COVER SHEET PATENTS ONLY



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HITA-0218

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Name of Conveying Party(ies):

(1) YOSHIHIKO INOUE, (2) HISASHI MOTOMURA AND (3) MASASHI HORIGUCHI

Additional names of conveying parties attached

3. Nature of Conveyance:

☑ AssignmentSecurity Agreement

Merger

Change of Name

Other:

Execution Dates: (1) April 19, 2002,

(2)April 24, 2002 and (3) April 22, 2002

4. (a) Patent Application Number(s):

If this document is being filed together with a new application, the execution date of the application is:

(1) April 19, 2002, (2)April 24, 2002 and (3) April 22, 2002

Additional Numbers Attached.

5. Name and Address of Party to whom Correspondence Concerning this Document Should be Mailed:

Name:

Stanley P. Fisher

Address: Reed Smith LLP 3100 Fairview Park Dr.

Suite 1400

Falls Church, Va. 22042

2. Name and Address of Receiving Party(ies):

(1) Name: Hitachi, Ltd.

Address: 6, Kanda Surugadai 4-chome

Chiyoda-ku, Tokyo, Japan

and

(2) Name: Hitachi ULSI Systems Co. Ltd

Address: 22-1 Josuihoncho 5-chome

Kodaira-shi, Toyko, Japan

10/192615

4. (b) Patent Numbers:

6. Total Number of Applications and Patents Involved: 1

7. Total Fee: **\$40.00** (37 C.F.R. § 3.41)

⊠ Enclosed.

8. Deposit Account Number: 08-1480

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9. Statement and Signature:

To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.

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July 11, 2002

Stanley P. Fisher, Registration No. 24, 344

Total number of pages comprising cover sheet: 1

n Carlos A. Marquez, Registration No. 34,072

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PATENT REEL: 013099 FRAME: 0641

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD. and Hitachi ULSI Systems Co., Ltd., corporations organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, and 22-1, Josuihoncho 5-chome, Kodaira-shi, Tokyo, Japan, respectively, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD. and Hitachi ULSI Systems Co., Ltd., their successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR MEMORY

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire owner ship of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD. and Hitachi ULSI Systems Co., Ltd., their successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made:

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD. and Hitachi ULSI Systems Co., Ltd.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

RECORDED: 07/11/2002

	(発明者フルネームサイン)	(署名日)
1)	Yoshihiko Inoue (Yoshihiko INOUE)	19/April/2002
2) .	Hisashi Motomura (Hisashi MOTOMURA)	24/April/2002
	Masashi Honguchi (Masashi HORIGUCHI)	
4) .		
-, -		

PATENT REEL: 013099 FRAME: 0642

Date Signed